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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	16
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	224 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f627-04-ss

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3.2.2.1 STATUS Register

The STATUS register, shown in Register 3-1, contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory (SRAM).

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the TO and PD bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear the upper-three bits and set the Z bit. This leaves the STATUS register as 000uu1uu (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register because these instructions do not affect any STATUS bit. For other instructions, not affecting any STATUS bits, see the "Instruction Set Summary".

Note 1: The <u>C</u> and <u>DC</u> bits operate as a Borrow and <u>Digit</u> Borrow out bit, respectively, in subtraction. See the <u>SUBLW</u> and <u>SUBWF</u> instructions for examples.

REGISTER 3-1:	STATUS REGISTER (ADDRESS: 03h, 83h, 103h, 183	3h)
---------------	---	-----

	R/W-0	R/W-0	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x				
	IRP	RP1	RP0	TO	PD	Z	DC	С				
	bit 7							bit 0				
bit 7	IRP : Regist 1 = Bank 2	ter Bank Sel , 3 (100h - 1	ect bit (use FFh)	d for indired	t addressing)							
bit 6-5	RP1:RP0: 00 = Bank 01 = Bank 10 = Bank 11 = Bank	Register Bai 0 (00h - 7Fh 1 (80h - FFh 2 (100h - 17 3 (180h - 1F	nk Select bi i) i) i) Fh) iFh)	its (used for	direct addressi	ng)						
bit 4	TO: Timeout bit 1 = After power-up, CLRWDT instruction, or SLEEP instruction 0 = A WDT timeout occurred											
bit 3	PD : Power-down bit 1 = After power-up or by the CLRWDT instruction 0 = By execution of the SLEEP instruction											
bit 2	 Z: Zero bit 1 = The result of an arithmetic or logic operation is zero 0 = The result of an arithmetic or logic operation is not zero 											
bit 1	 0 = The result of an arithmetic or logic operation is not zero DC: Digit carry/borrow bit (ADDWF, ADDLW, SUBLW, SUBWF instructions) (for borrow the polarity is reversed) 1 = A carry-out from the 4th low order bit of the result occurred 0 = No carry-out from the 4th low order bit of the result 											
bit 0	 0 = No carry-out from the 4th low order bit of the result C: Carry/borrow bit (ADDWF, ADDLW, SUBLW, SUBWF instructions) 1 = A carry-out from the Most Significant bit of the result occurred 0 = No carry-out from the Most Significant bit of the result occurred Note 1: For borrow the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either the high or low order bit of the course register. 											
	Legend:											
	R = Reada	ble bit	VV = V	Vritable bit	U = Unimple	emented b	it, read as '(0'				
	-n = Value	at POR	'1' = E	Bit is set	'0' = Bit is c	leared	x = Bit is ur	nknown				



FIGURE 5-7: BLOCK DIAGRAM OF RA7/OSC1/CLKIN PIN

7.1 Timer1 Operation in Timer Mode

Timer mode is selected by clearing the TMR1CS (T1CON<1>) bit. In this mode, the input clock to the timer is FOSC/4. The synchronize control bit T1SYNC (T1CON<2>) has no effect since the internal clock is always in sync.

7.2 Timer1 Operation in Synchronized Counter Mode

Counter mode is selected by setting bit TMR1CS. In this mode the timer increments on every rising edge of clock input on pin RB7/T1OSI when bit T1OSCEN is set or pin RB6/T1OSO/T1CKI when bit T1OSCEN is cleared.

If TISYNC is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple-counter.

In this configuration, during SLEEP mode, Timer1 will not increment even if the external clock is present, since the synchronization circuit is shut off. The prescaler however will continue to increment.

7.2.1 EXTERNAL CLOCK INPUT TIMING FOR SYNCHRONIZED COUNTER MODE

When an external clock input is used for Timer1 in Synchronized Counter mode, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of TMR1 after synchronization.

When the prescaler is 1:1, the external clock input is the same as the prescaler output. The synchronization of T1CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, it is necessary for T1CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the appropriate electrical specifications, parameters 45, 46, and 47.

When a prescaler other than 1:1 is used, the external clock input is divided by the asynchronous ripplecounter type prescaler so that the prescaler output is symmetrical. In order for the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for T1CKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T1CKI high and low time is that they do not violate the minimum pulse width requirements of 10 ns). Refer to the appropriate electrical specifications, parameters 40, 42, 45, 46, and 47.



FIGURE 7-1: TIMER1 BLOCK DIAGRAM

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REGISTER 8-1:	T2CON	I: TIMER C	ONTROL F	REGISTER	(ADDRESS:	12h)						
	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
		TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0				
	bit 7							bit 0				
bit 7	Unimplem	ented: Read	as '0'									
bit 6-3	TOUTPS3:	TOUTPS0: 1	imer2 Outpu	ut Postscale	Select bits							
	0000 = 1:1	1000 = 1:1 Postscale Value										
	0001 = 1:2 Postscale Value											
	•											
	•											
	•											
	1111 = 1:1	6 Postscale										
bit 2	TMR2ON:	Timer2 On bi	t									
	1 = Timer2	is on										
	0 = Timer2	is off										
bit 1-0	T2CKPS1:	T2CKPS0: T	imer2 Clock	Prescale Se	lect bits							
	00 = 1:1 Pr	escaler Valu	е									
	01 = 1:4 Pr	escaler Valu	е									
	1x = 1:16 F	Prescaler Val	ue									
	Legend:											

	-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknow
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W = Writable bit

U = Unimplemented bit, read as '0'

TABLE 8-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER

R = Readable bit

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other RESETS
0Bh/8Bh/ 10Bh/18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	EEIF	CMIF	RCIF	TXIF	_	CCP1IF	TMR2IF	TMR1IF	0000 -000	0000 -000
8Ch	PIE1	EEIE	CMIE	RCIE	TXIE	_	CCP1IE	TMR2IE	TMR1IE	0000 -000	0000 -000
11h	TMR2	Timer2 module's register									0000 0000
12h	T2CON		TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
92h	PR2	Timer2 Peri	od Register							1111 1111	1111 1111

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by the Timer2 module.

11.2.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

11.2.3 SOFTWARE INTERRUPT MODE

When generate software interrupt is chosen, the CCP1 pin is not affected. Only a CCP interrupt is generated (if enabled).

11.2.4 SPECIAL EVENT TRIGGER

In this mode, an internal hardware trigger is generated which may be used to initiate an action.

The special event trigger output of CCP1 resets the TMR1 register pair. This allows the CCPR1 register to effectively be a 16-bit programmable period register for Timer1.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Valu PC	e on DR	Value on all other RESETS	
0Bh/8Bh/ 10Bh/ 18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	EEIF CMIF RCIF TXIF — CCP1IF TMR2IF TMR1IF							0000	-000	0000	-000	
8Ch	PIE1	EEIE CMIF RCIE TXIE — CCP1IE TMR2IE TMR1IE							0000	-000	0000	-000	
87h	TRISB	PORTB	PORTB Data Direction Register									1111	1111
0Eh	TMR1L	Holding	register	for the Lea	st Significar	nt Byte of the	e 16-bit TM	R1 registe	r	xxxx	xxxx	uuuu	uuuu
0Fh	TMR1H	Holding	register	for the Mos	t Significan	t Byte of the	16-bit TM	R1register		xxxx	xxxx	uuuu	uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00	0000	uu	uuuu
15h	CCPR1L	Capture	Capture/Compare/PWM register1 (LSB)								xxxx	uuuu	uuuu
16h	CCPR1H	Capture	Capture/Compare/PWM register1 (MSB)								xxxx	uuuu	uuuu
17h	CCP1CON		_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00	0000	00	0000

TABLE 11-3: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, AND TIMER1

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by Capture and Timer1.

12.0 UNIVERSAL SYNCHRONOUS/ ASYNCHRONOUS RECEIVER/ TRANSMITTER (USART) MODULE

The Universal Synchronous Asynchronous Receiver Transmitter (USART) module is one of the two serial I/O modules. (USART is also known as a Serial Communications Interface or SCI). The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices such as CRT terminals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices such as A/D or D/ A integrated circuits, Serial EEPROMs etc. The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous Master (half duplex)
- Synchronous Slave (half duplex)

Bit SPEN (RCSTA<7>), and bits TRISB<2:1>, have to be set in order to configure pins RB2/TX/CK and RB1/ RX/DT as the Universal Synchronous Asynchronous Receiver Transmitter.

REGISTER 12-1: TXSTA: TRANSMIT STATUS AND CONTROL REGISTER (ADDRESS: 98h)

	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-1	R/W-0				
	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D				
	bit 7							bit 0				
bit 7	CSRC: Cloc	k Source Sel	ect bit									
	Asynchronou Don't car	us mode										
	Synchronou	s m <u>ode</u>										
	1 = Maste	er mode (Clo	ck generated	internally fro	m BRG)							
	0 = Slave	0 = Slave mode (Clock from external source)										
bit 6	TX9 : 9-bit Tr	ransmit Enabl	le bit									
	1 = Selects $30 = $ Selects 3	= Selects 9-bit transmission = Selects 8-bit transmission										
hit 5	TXFN: Tran	= Selects 8-bit transmission										
	1 = Transmi	Transmit Enable bit''										
	0 = Transmi f) = Transmit disabled										
bit 4	SYNC: USA	RT Mode Sel	lect bit									
	1 = Synchro	nous mode										
L 14 O		onous moue	101									
DIT 3		nteo: Reau a										
bit 2	Asynchrono	I Baud Rate S	Select bit									
	1 = High	speed										
	0 = Low s	speed										
	Synchronous	<u>s mode</u>										
1 11 A		1 this mode	Ster OTATU	0								
DIT	1 = TSR em	SMIT SHIIT REQ intv	JISTER STATUS	SDI								
	0 = TSR full	μιγ										
bit 0	TX9D : 9th b ⁱ	it of transmit	data. Can be	PARITY bit.								
	Note 1: S	REN/CREN	overrides TX	EN in SYNC	mode							
	Legend:											
	R = Reada	ıble bit	W = V	Vritable bit	U = Unimpl	emented b	it, read as '	0'				
	-n = Value	at POR	'1' = E	Bit is set	'0' = Bit is c	leared	x = Bit is ur	nknown				

12.1 USART Baud Rate Generator (BRG)

The BRG supports both the Asynchronous and Synchronous modes of the USART. It is a dedicated 8-bit baud rate generator. The SPBRG register controls the period of a free running 8-bit timer. In Asynchronous mode bit BRGH (TXSTA<2>) also controls the baud rate. In Synchronous mode bit BRGH is ignored. Table 12-1 shows the formula for computation of the baud rate for different USART modes which only apply in Master mode (internal clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRG register can be calculated using the formula in Table 12-1. From this, the error in baud rate can be determined.

Example 12-1 shows the calculation of the baud rate error for the following conditions:

Fosc = 16 MHz Desired Baud Rate = 9600 BRGH = 0

SYNC = 0

EXAMPLE 12-1: CALCULATING BAUD RATE ERROR

Desired Baud rate = Fosc / (64(X + 1))

9600 = 16000000 / (64(+1))X X = $\hat{1}25.042^{\circ}$

Calculated Baud Rate = 16000000 / (64(25 + 1)) = 9615

Error = (<u>Calculated Baud Rate = Desired Baud Rate</u>) Desired Baud Rate

> = (9615 - 9600)/ 9600 = 0.16%

It may be advantageous to use the high baud rate (BRGH = 1) even for slower baud clocks. This is because the Fosc/(16(X + 1)) equation can reduce the baud rate error in some cases.

Writing a new value to the SPBRG register, causes the BRG timer to be RESET (or cleared), this ensures the BRG does not wait for a timer overflow before outputting the new baud rate.

TABLE 12-1: BAUD RATE FORMULA

SYNC	BRGH = 0 (Low Speed)	BRGH = 1 (High Speed)
0	(Asynchronous) Baud Rate = Fosc/(64(X+1))	Baud Rate= Fosc/(16(X+1))
1	(Synchronous) Baud Rate = Fosc/(4(X+1))	NA

Legend: X = value in SPBRG (0 to 255)

TABLE 12-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other RESETS
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
18h	RCSTA	SPEN	RX9	SREN	CREN	ADEN	FERR	OERR	RX9D	x00- 0000	0000 -00x
99h SPBRG Baud Rate Generator Register										0000 0000	0000 0000

Legend: x = unknown, - = unimplemented read as '0'.

Shaded cells are not used by the BRG.

Steps to follow when setting up an Asynchronous Reception:

- 1. Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, set bit BRGH. (Section 12.1).
- 2. Enable the asynchronous serial port by clearing bit SYNC, and setting bit SPEN.
- 3. If interrupts are desired, then set enable bit RCIE.
- 4. If 9-bit reception is desired, then set bit RX9.
- 5. Enable the reception by setting bit CREN.
- 6. Flag bit RCIF will be set when reception is complete and an interrupt will be generated if enable bit RCIE was set.
- 7. Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- 8. Read the 8-bit received data by reading the RCREG register.
- 9. If any error occurred, clear the error by clearing enable bit CREN.

TABLE 12-7:	REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION
-------------	---

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other RESETS
0Ch	PIR1	EEIF	CMIF	RCIF	TXIF		CCP1IF	TMR2IF	TMR1IF	0000 -00	0000 -000
18h	RCSTA	SPEN	RX9	SREN	CREN	ADEN	FERR	OERR	RX9D	0000 -00:	x 0000 -00x
1Ah	RCREG USART Receive Register										0000 0000
8Ch	PIE1	EEIE	CMIE	RCIE	TXIE	_	CCP1IE	TMR2IE	TMR1IE	0000 -00	0000-0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	-	BRGH	TRMT	TX9D	0000 -01	0 0000 -010
99h	h SPBRG Baud Rate Generator Register									0000 000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Asynchronous Reception.

12.4 USART Synchronous Master Mode

In Synchronous Master mode, the data is transmitted in a half-duplex manner (i.e., transmission and reception do not occur at the same time). When transmitting data, the reception is inhibited and vice versa. Synchronous mode is entered by setting bit SYNC (TXSTA<4>). In addition, enable bit SPEN (RCSTA<7>) is set in order to configure the RB2/TX/CK and RB1/RX/DT I/O pins to CK (clock) and DT (data) lines respectively. The Master mode indicates that the processor transmits the master clock on the CK line. The Master mode is entered by setting bit CSRC (TXSTA<7>).

12.4.1 USART SYNCHRONOUS MASTER TRANSMISSION

The USART Transmitter Block Diagram is shown in Figure 12-5. The heart of the transmitter is the Transmit (serial) Shift register (TSR). The Shift register obtains its data from the read/write transmit buffer register TXREG. The TXREG register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from the TXREG (if available). Once the TXREG register transfers the data to the TSR register (occurs in one Tcycle), the TXREG is empty and interrupt bit, TXIF (PIR1<4>) is set. The interrupt can be enabled/disabled by setting/clearing enable bit TXIE (PIE1<4>). Flag bit TXIF will be set regardless of the state of enable bit TXIE and cannot be cleared in software. It will RESET only when new data is loaded into the TXREG register. While flag bit TXIF indicates the status of the TXREG register, another bit TRMT (TXSTA<1>) shows the status of the TSR register. TRMT is a read only bit which is set when the TSR is empty. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR register is empty. The TSR is not mapped in data memory so it is not available to the user.

Transmission is enabled by setting enable bit TXEN (TXSTA<5>). The actual transmission will not occur until the TXREG register has been loaded with data. The first data bit will be shifted out on the next available rising edge of the clock on the CK line. Data out is stable around the falling edge of the synchronous clock (Figure 12-12). The transmission can also be started by first loading the TXREG register and then setting bit TXEN (Figure 12-13). This is advantageous when slow baud rates are selected, since the BRG is kept in RESET when bits TXEN, CREN, and SREN are clear. Setting enable bit TXEN will start the BRG, creating a shift clock immediately. Normally when transmission is first started, the TSR register is empty, so a transfer to the TXREG register will result in an immediate transfer to TSR resulting in an empty TXREG. Back-to-back transfers are possible.

Clearing enable bit TXEN, during a transmission, will cause the transmission to be aborted and will RESET the transmitter. The DT and CK pins will revert to hiimpedance. If either bit CREN or bit SREN is set, during a transmission, the transmission is aborted and the DT pin reverts to a hi-impedance state (for a reception). The CK pin will remain an output if bit CSRC is set (internal clock). The transmitter logic however is not RESET although it is disconnected from the pins. In order to RESET the transmitter, the user has to clear bit TXEN. If bit SREN is set (to interrupt an on-going transmission and receive a single word), then after the single word is received, bit SREN will be cleared and the serial port will revert back to transmitting since bit TXEN is still set. The DT line will immediately switch from Hi-impedance Receive mode to transmit and start driving. To avoid this, bit TXEN should be cleared.

In order to select 9-bit transmission, the TX9 (TXSTA<6>) bit should be set and the ninth bit should be written to bit TX9D (TXSTA<0>). The ninth bit must be written before writing the 8-bit data to the TXREG register. This is because a data write to the TXREG can result in an immediate transfer of the data to the TSR register (if the TSR is empty). If the TSR was empty and the TXREG was written before writing the "new" TX9D, the "present" value of bit TX9D is loaded.

Steps to follow when setting up a Synchronous Master Transmission:

- 1. Initialize the SPBRG register for the appropriate baud rate (Section 12.1).
- 2. Enable the synchronous master serial port by setting bits SYNC, SPEN, and CSRC.
- 3. If interrupts are desired, then set enable bit TXIE.
- 4. If 9-bit transmission is desired, then set bit TX9.
- 5. Enable the transmission by setting bit TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- 7. Start transmission by loading data to the TXREG register.

FIGURE 14-2: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT



Figure 14-3 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180° phase shift in a series resonant oscillator circuit. The 330 k Ω resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 14-3: EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT



14.2.4 EXTERNAL CLOCK IN

For applications, where a clock is already available elsewhere, users may directly drive the PIC16F62X provided that this external clock source meets the AC/DC timing requirements listed in Section 17.4. Figure 14-4 shows how an external clock circuit should be configured.



14.2.5 ER OSCILLATOR

For timing insensitive applications, the ER (External Resistor) Clock mode offers additional cost savings. Only one external component, a resistor to VSs, is needed to set the operating frequency of the internal oscillator. The resistor draws a DC bias current which controls the oscillation frequency. In addition to the resistance value, the oscillator frequency will vary from unit to unit, and as a function of supply voltage and temperature. Since the controlling parameter is a DC current and not a capacitance, the particular package type and lead frame will not have a significant effect on the resultant frequency.

Figure 14-5 shows how the controlling resistor is connected to the PIC16F62X. For REXT values below 10k, the oscillator operation becomes sensitive to temperature. For very high REXT values (e.g., 1M), the oscillator becomes sensitive to leakage and may stop completely. Thus, we recommend keeping REXT between 10k and 1M.





Table 14-3 shows the relationship between the resistance value and the operating frequency.

TABLE 14-3: RESISTANCE AND FREQUENCY RELATIONSHIP

Resistance	Frequency			
0	10.4 MHz			
1K	10 MHz			
10K	7.4 MHz			
20K	5.3 MHz			
47K	3 MHz			
100K	1.6 MHz			
220K	800 kHz			
470K	300 kHz			
1M	200 kHz			

The ER Oscillator mode has two options that control the unused OSC2 pin. The first allows it to be used as a general purpose I/O port. The other configures the pin as an output providing the Fosc signal (internal clock divided by 4) for test or external synchronization purposes.

14.2.6 INTERNAL 4 MHz OSCILLATOR

The internal RC oscillator provides a fixed 4 MHz (nominal) system clock at VDD = 5V and $25^{\circ}C$, see "Electrical Specifications" section for information on variation over voltage and temperature.

14.2.7 CLKOUT

The PIC16F62X can be configured to provide a clock out signal by programming the configuration word. The oscillator frequency, divided by 4 can be used for test purposes or to synchronize other logic.

14.3 Special Feature: Dual Speed Oscillator Modes

A software programmable Dual Speed Oscillator mode is provided when the PIC16F62X is configured in either ER or INTRC Oscillator modes. This feature allows users to dynamically toggle the oscillator speed between 4 MHz and 37 kHz. In ER mode, the 4 MHz setting will vary depending on the value of the external resistor. Also in ER mode, the 37 kHz operation is fixed and does not vary with resistor value. Applications that require low current power savings, but cannot tolerate putting the part into SLEEP, may use this mode.

The OSCF bit in the PCON register is used to control Dual Speed mode. See Section 3.2.2.6, Register 3-4.

14.4 RESET

The PIC16F62X differentiates between various kinds of RESET:

- a) Power-on Reset (POR)
- b) MCLR Reset during normal operation
- c) MCLR Reset during SLEEP
- d) WDT Reset (normal operation)
- e) WDT Wake-up (SLEEP)
- f) Brown-out Detect (BOD)

Some registers are not affected in any RESET condition; their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on Power-on Reset, MCLR Reset, WDT Reset and MCLR Reset during SLEEP. They are not affected by a WDT Wake-up, since this is viewed as the resumption of normal operation. TO and PD bits are set or cleared differently in different RESET situations as indicated in Table 14-5. These bits are used in software to determine the nature of the RESET. See Table 14-8 for a full description of RESET states of all registers.

A simplified block diagram of the on-chip RESET circuit is shown in Figure 14-6.

The MCLR Reset path has a noise filter to detect and ignore small pulses. See Table 17-6 for pulse width specification.



FIGURE 14-11: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)

- Note 1: External Power-on Reset circuit is required only if VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
 - **2:** $R < 40 \text{ k}\Omega$ is recommended to make sure that voltage drop across R does not violate the device's electrical specification.
 - **3:** R1 = 100Ω to $1 k\Omega$ will limit any current flowing into MCLR from external capacitor C in the event of MCLR/VPP pin breakdown due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

FIGURE 14-12: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1



FIGURE 14-13: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2



14.9.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

- 1. External RESET input on \overline{MCLR} pin
- 2. Watchdog Timer Wake-up (if WDT was enabled)
- 3. Interrupt from RB0/INT pin, RB Port change, or the Peripheral Interrupt (Comparator).

The first event will cause a device RESET. The two latter events are considered a continuation of program execution. The TO and PD bits in the STATUS register can be used to determine the cause of device RESET. PD bit, which is set on power-up is cleared when SLEEP is invoked. TO bit is cleared if WDT Wake-up occurred.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the

corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have an NOP after the SLEEP instruction.

Note: If the global interrupts are disabled (GIE is cleared), but any interrupt source has both its interrupt enable bit and the corresponding interrupt flag bits set, the device will immediately wake-up from SLEEP. The SLEEP instruction is completely executed.

The WDT is cleared when the device wakes-up from SLEEP, regardless of the source of wake-up.

FIGURE 14-17: WAKE-UP FROM SLEEP THROUGH INTERRUPT

		Q1 Q2 Q3 Q4;	Q1 Q2 Q3 Q4; (Q1 Q2 Q3 Q4
	<u>tt-/</u> / \	/ <u>¦</u>		/ i
INT pin	· · ·	I	I	
	Interrupt Latency	v		
	(Note 2)	, 1	→	
(INTCON<7>)	! !	<u> </u>	<u> </u>	<u> </u>
SLEEP	i i			1
INSTRUCTION FLOW	· · ·	1	1	1
PC X PC X PC+1 X PC+2	X PC+2 X	PC + 2	(<u>0004h X</u>	0005h
Instruction { Inst(PC) = SLEEP Inst(PC + 1)	Inst(PC + 2)	1 1 1	Inst(0004h)	Inst(0005h)
Instruction { Inst(PC - 1) SLEEP	Inst(PC + 1)	Dummy cycle	Dummy cycle	Inst(0004h)
Note 1: XT, HS or LP Oscillator mode assumed.				
2: TOST = 1024TOSC (drawing not to scale). Approximation	tely 1 μ s delay will be	there for ER Os	c mode.	
 GIE = '1' assumed. In this case after wake- up, the pr in-line. 	rocessor jumps to the i	interrupt routine.	If GIE = '0', execu	ution will continue
4: CLKOUT is not available in these Osc modes, but sl	nown here for timing re	eference.		

14.10 Code Protection

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

Note: The entire data EEPROM and FLASH program memory will be erased when the code protection is turned off. The INTRC calibration data is not erased.

14.11 User ID Locations

Four memory locations (2000h-2003h) are designated as user ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify. Only the Least Significant 4 bits of the user ID locations are used.

PIC16F62X

CLRW	Clear V	V				COMF
Syntax:	[label]	CLRW				Syntax
Operands:	None					Opera
Operation:	$00h \rightarrow 0$ $1 \rightarrow Z$	(W)				Opera
Status Affected:	Z					Status
Encoding:	00	0001	0000	0011		Encod
Description:	W register is cleared. Zero bit (Z) is set.					Descri
Words:	1					
Cycles:	1					
Example	CLRW					Words
	Before Instruction					Cycles
	W = 0x5A After Instruction $W = 0x00$ $Z = 1$					Examp

COMF	Complement f			
Syntax:	[label]	COMF	f,d	
Operands:	$\begin{array}{l} 0\leq f\leq 12\\ d\in[0,1] \end{array}$	27		
Operation:	$(\overline{f}) \rightarrow (de$	est)		
Status Affected:	Z			
Encoding:	00	1001	dfff	ffff
Description:	complemented. If 'd' is 0 the result is stored in W. If 'd' is 1 the result is stored back in register 'f'.			
Words:	1			
Cycles:	1			
Example	COMF	REG1,	0	
	Before Ir R After Ins R V	nstructio REG1 = truction REG1 = V =	n 0x13 0x13 0xEC	

CLRWDT	Clear Watchdog Timer			
Syntax:	[label] CLRWDT	Syntax:		
Operands:	None	Operands:		
Operation:	$\begin{array}{l} 00h \rightarrow WDT \\ 0 \rightarrow \underline{WDT} \text{ prescaler,} \\ 1 \rightarrow \underline{TO} \\ 1 \rightarrow \overline{PD} \end{array}$	Operation: Status Affecte		
Status Affected:	TO, PD	Encoding:		
Encoding:	00 0000 0110 0100	Description:		
Description:	CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. STATUS bits TO and PD are set Words:			
Words:	1	Cycles:		
Cycles:	1	Example		
Example	CLRWDT			
	Before Instruction WDT counter = ? After Instruction WDT counter = $0x00$ WDT prescaler = 0 TO = 1 PD = 1			

DECF	Decrement f			
Syntax:	[label] DECF f,d			
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$			
Operation:	(f) - 1 \rightarrow (dest)			
Status Affected:	Z			
Encoding:	00 0011 dfff ffff			
Description:	Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.			
Words:	1			
Cycles:	1			
Example	DECF CNT, 1			
	Before Instruction CNT = 0x01 Z = 0 After Instruction CNT = 0x00 Z = 1			

RETLW	Return with Literal in W	RLF	Rotate Left f through Carry
Syntax:	[<i>label</i>] RETLW k	Syntax:	[<i>label</i>] RLF f,d
Operands:	$0 \le k \le 255$	Operands:	$0 \leq f \leq 127$
Operation:	$k \rightarrow (W);$ TOS \rightarrow PC	Operation:	$d \in [0,1]$ See description below
Status Affected:	None	Status Affected:	C
Encoding:	11 01xx kkkk kkkk	Encoding:	00 1101 dfff ffff
Description:	The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.	Description:	The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is stored back in register 'f'.
Words:	1		
Cycles:	2	Words	1
Example	CALL TABLE;W contains table	Cycles:	1
	• ;W now has table	Example	RLF REGIO
TABLE	• • ADDWF PC ;W = offset RETLW k1 ;Begin table RETLW k2 ; • • • RETLW kn ; End of table Before Instruction W = 0x07 After Instruction W = value of k8		Before Instruction REG1 = 1110 0110 C = 0 After Instruction REG1 = 1110 0110 W = 1100 1100 C = 1
RETURN	Return from Subroutine		
Syntax:	[label] RETURN		
Operands:	None		
Operation:	$TOS\toPC$		
Status Affected:	None		
Encoding:	00 0000 0000 1000		
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two-cycle instruction.		
Words:	1		
Cycles:	2		
Example	RETURN		
	After Interrupt PC = TOS		

PIC16F62X











FIGURE 17-4: PIC16LF62X VOLTAGE-FREQUENCY GRAPH, -40°C \leq TA < 0°C, +70°C < TA \leq 85°C



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Note: The graphs and tables provided in this section are for design guidance and are not tested.



FIGURE 18-24: MAXIMUM IDD vs VDD OVER TEMPERATURE (-40 TO +125°C) INTERNAL 37 kHz OSCILLATOR

FIGURE 18-25: TYPICAL IDD VS VDD OVER TEMPERATURE (-40 TO +125°C) INTERNAL 37 kHz OSCILLATOR







	Units	INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	р		.050			1.27	
Overall Height	Α	.093	.099	.104	2.36	2.50	2.64
Molded Package Thickness	A2	.088	.091	.094	2.24	2.31	2.39
Standoff §	A1	.004	.008	.012	0.10	0.20	0.30
Overall Width	Е	.394	.407	.420	10.01	10.34	10.67
Molded Package Width	E1	.291	.295	.299	7.39	7.49	7.59
Overall Length	D	.446	.454	.462	11.33	11.53	11.73
Chamfer Distance	h	.010	.020	.029	0.25	0.50	0.74
Foot Length	L	.016	.033	.050	0.41	0.84	1.27
Foot Angle	¢	0	4	8	0	4	8
Lead Thickness	С	.009	.011	.012	0.23	0.27	0.30
Lead Width	В	.014	.017	.020	0.36	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter § Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MS-013 Drawing No. C04-051